FAIRCHILD

SEMICONDUCTOR®

FDD8451 N-Channel PowerTrench[®] MOSFET 40V, 28A, 24m Ω

Features

- Max $r_{DS(on)} = 24m\Omega$ at $V_{GS} = 10V$, $I_D = 9A$
- Max $r_{DS(on)}$ = 30m Ω at V_{GS} = 4.5V, I_D = 7A
- Low gate charge
- Fast Switching
- High performance trench technology for extremely low r_{DS(on)}
- RoHS compliant



April 2006

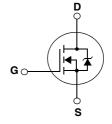
General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, fast switching speed and extremely low $r_{DS(on)}$.

Application

- DC/DC converter
- Backlight inverter



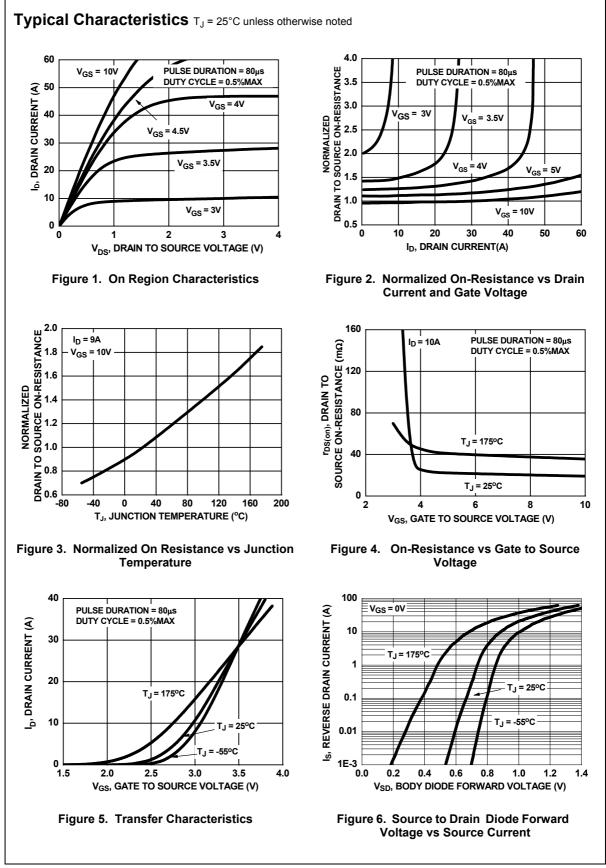


MOSFET Maximum Ratings $T_C = 25^{\circ}C$ unless otherwise noted

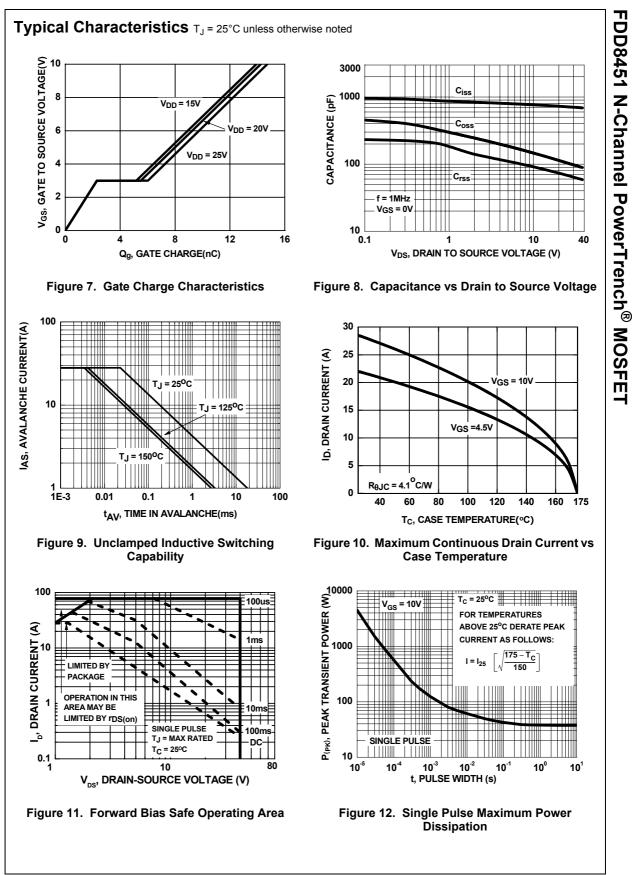
Symbol	Parameter				Ratings	Units
V _{DS}	Drain to S	Drain to Source Voltage			40	V
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous @T _C =25°C				28	
D	-Continuous @T _A =25°C				9	A
_		-Pulsed	-Pulsed (Note 1) 7			
E _{AS}	Single Pulse Avalanche Energy (Note 2)			(Note 2)	20	mJ
P _D	Power Di	Power Dissipation			37	W
T _J , T _{STG}	Operating	ating and Storage Temperature			-55 to 150	°C
Thermal	Chara	cteristics				
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case				4.1	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient				40	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient			96	°C/W	
Package	Marki	ng and Orderin	g Information			i.
Device N	larking	Device	Package	Reel Size	Tape Width	Quantity
FDD8451		FDD8451	D-PAK(TO-252)	13"	12mm	2500 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	40			V	
ΔBV_{DSS} $\Delta T_{,l}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to $25^{\circ}C$		33.5		mV/°C	
DSS	Zero Gate Voltage Drain Current	V _{DS} = 32V, V _{GS} = 0V			1	μA	
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20V, V_{DS} = 0V			±100	nA	
	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250μA	1	1.7	3	V	
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage	$I_{D} = 250 \mu A$, referenced to		1.7		-	
ΔT_J	Temperature Coefficient	25°C		-5.7		mV/°C	
r _{DS(on)}	Drain to Source On Resistance	V _{GS} = 10V, I _D = 9A		19	24		
		V _{GS} = 4.5V, I _D = 7A		23	30	mΩ	
		V _{GS} = 10V, I _D = 9A T _J = 150°C		32	41		
9 _{FS}	Forward Transcondductance	V _{DS} = 5V, I _D = 9A		29		S	
C _{iss}	Characteristics Input Capacitance	$V_{22} = 20 V V_{22} = 0 V$		742	990	pF	
C _{oss}	Output Capacitance	V _{DS} = 20V, V _{GS} = 0V, f = 1MHz		112	150	pF	
C _{rss}	Reverse Transfer Capacitance			72	110	pF	
R _g	Gate Resistance	f = 1MHz		1.1		Ω	
Switching	g Characteristics						
t _{d(on)}	Turn-On Delay Time			7	14	ns	
t _r	Rise Time	$V_{DD} = 20V, I_D = 1A$		2	10	ns	
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10V, R_{GS} = 6 Ω		19	34	ns	
l _f	Fall Time			5	10	ns	
Q _q	Total Gate Charge at 10V			14	20	nC	
Q _g	Total Gate Charge at 5V	V _{DS} = 20V, I _D = 9A		7.7	11	nC	
Q _{gs}	Gate to Source Gate Charge	V _{GS} = 10V		2.3		nC	
Q _{gd}	Gate to Drain "Miller"Charge			3.2		nC	
Drain-Sou	urce Diode Characteristics						
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 9A$		0.87	1.2	V	
t _{rr}	Reverse Recovery Time	$I_{\rm F} = 9$ A, di/dt = 100A/µs		25	38	ns	
		1 P P P P P P P P P P P P P P P P P P P			1		

2: Starting $T_J = 25^{\circ}C$, L = 0.1mH, $I_{AS} = 20A$, $V_{DD} = 36V$, $V_{GS} = 10V$.

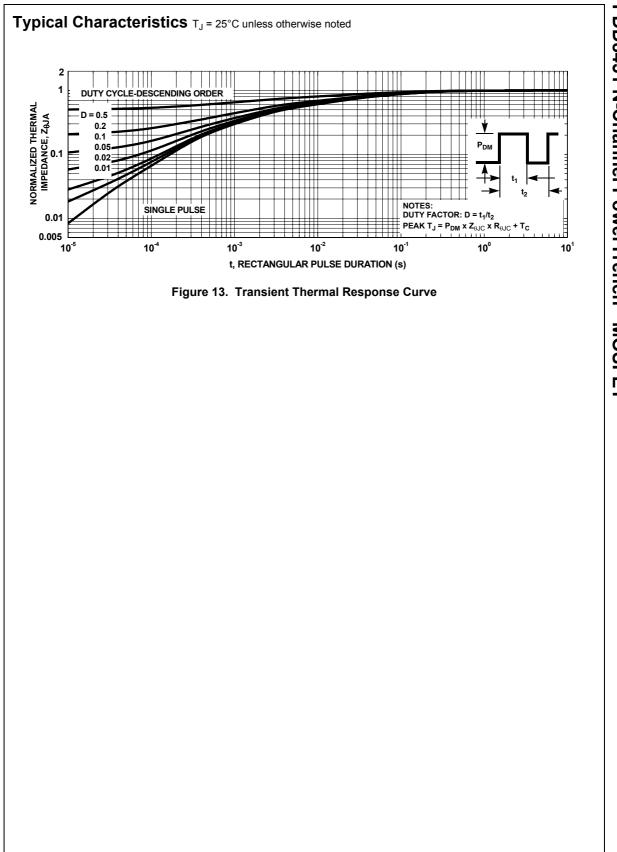


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FDD8451 Rev. B

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ACEx™	FAST [®]	ISOPLANAR™	PowerEdge™	SuperFET™
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Bottomless™	FPS™	MICROCOUPLER™	PowerTrench [®]	SuperSOT™-6
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CoolFET™	GlobalOptoisolator™	MicroPak™	QS™	SyncFET™
CROSSVOLT™	GTO™	MICROWIRE™	QT Optoelectronics™	TCM™
DOME™	HiSeC™	MSX™	Quiet Series [™]	TinyLogic [®]
EcoSPARK™	l ² C™	MSXPro™	RapidConfigure™	TINYOPTO™
E ² CMOS™	i-Lo™	OCX™	RapidConnect™	TruTranslation™
EnSigna™	ImpliedDisconnect [™]	OCXPro™	µSerDes™	UHC™
FACT™	IntelliMAX™	OPTOLOGIC [®]	ScalarPump™	UltraFET®
FACT Quiet Series [™]		OPTOPLANAR™	SILENT SWITCHER [®]	UniFET™
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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS	DEFINITIONS
Definition of Terms	

Datasheet Identification	Product Status	Definition		
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.		
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	•	Rev. 119		

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